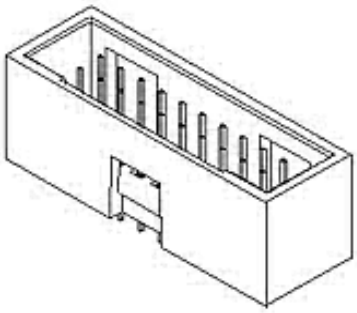


Part Number : 15800309
Product Description : 2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 3.81mm Inside Shroud to End Circuit Spacing
Series Number : 70567
Status : Active
Product Category : PCB Headers and Receptacles
Engineering Part Number : A-70567-0285

Documents & Resources

Drawings

015800309_sd.pdf

PK-70873-0018-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

PS-70567-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	70567
Description	2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 3.81mm Inside Shroud to End Circuit Spacing
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	800755031294

Agency

UL	E29179

Electrical

Current - Maximum per Contact	2.5A
Voltage - Maximum	250V DC

Physical

Breakaway	No
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	25
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	5.296/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	Yes
PCB Thickness - Recommended	2.36mm
PC Tail Length	3.30mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	Open Ends
Stackable	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	1
Max-Temp	245

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	71395
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	71850
SL Dual Row Crimp Housings	70450

Use with Part(s)

Description	Part Number
2.54mm SL Interim Clips	70013